











- ► PLCC6 LED with IC
- ▶ 1212 IC 0.75t
- ► Red/Green/Blue

NOM66S09IC





FEATURES:





Release Date: 27 March 2024 Version: A1.0

- Package: PLCC 6-Pins EIA STD Package with Integrated IC
- Forward Current: 3.63/3.63/3.63mA*
- Luminous Intensity (typ.): 460mcd mixed white
- Colour: Red/Green/Blue
- IC Feature:
 - ✓ Single data line employing a communication protocol that utilizes zero-return codes.
 - ✓ Built-in high-precision and high-stability oscillator. The serial data frequency is adjustable up to 1300kHz.
 - ✓ Data output re-shaping for accurate and long-distance transmission.
 - ✓ Built-in overvoltage protection.
 - ✓ 2 data input ports to allow breakpoint jumping.
- Pixel: Supports Support 65536 levels (16bits) grayscale adjustment of each R/G/B single channel. Maximum 12mA of constant current output for each R/G/B channel with 5 bits dimming level.
- Soldering methods: IR Reflow soldering
- MSL Level: acc. to JEDEC Level 3
- Packing: 8mm tape with max.4000pcs/reel, ø180mm (7")

* in order of Red/Green/Blue

APPLICATIONS:

- Telecommunication
- Status Indicator
- Home Appliance
- Decoration Lighting
- Full Colour LED Strip
- Gaming Device
- Guardrail Tube
- Indoor Display Screen



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	12	mA
IC Power Supply Voltage	V _{DD}	4.0~7.5	V
R/G/B Output Port Withstand Voltage	V _{ds}	max. 9	V
IC Input Voltage	Vı	-0.5~+5.5	V
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+85	°C
Junction Temperature	Tj	125	°C
Soldering Temperature	T _{SD}	260	°C
ESD Withstand Voltage acc. ANSI/ESDA/JEDEC JS-001	ESD	5	kV

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol		Values	Unit	Test	
raiailletei	Зуппоот	Min.	Тур.	Max.	Offic	Condition
Input Voltage	V_{DD}	4.5	5.0	5.5	V	
R/G/B Output Drive Current	I ₀	0.71	3.63	12	mA	V _{ds} =1V
Innut Voltage Level	V _{IH}	0.7V _{DD}			V	
Input Voltage Level	VIL			0.3V _{DD}	V	
Current Deviation	dlo		±3	±5	%	V _{ds} =1V; I _O =12mA
Dynamic IC Consumption	I _{dd.dyn}			1	mA	Data input, light off
Quiescent Current	I _{DD}			5	uA	No data in, light off



Electrical & Optical Characteristics (Ta=25°C, V_{DD}=5V)

Parameter		Symbol		Values			Test
Parameter		Зуппоот	Min.	Тур.	Max.	Unit	Condition
	R			70			I _F =3.63mA
Luminous Intensity	G			310			I _F =3.63mA
Luminous Intensity	В	- I _V		65		mcd	I _F =3.63mA
	W		320	460	630		I _F =10.89mA
	R			624			I _F =3.63mA
Dominant Wavelength	G	λ_{D}		528		nm	I _F =3.63mA
	В			469			I _F =3.63mA
Colour Coordinate	Х			0.2200			I _F =10.89mA
Colour Coordinate	Υ			0.2783			11-10.05IIIA
Viewing Angle		2θ _{1/2}		120		deg	I _F =10.89mA

^{1.} Luminous Intensity: ±10%mcd, Dominant Wavelength: ±1.0nm, Color Coordinate: ±0.005

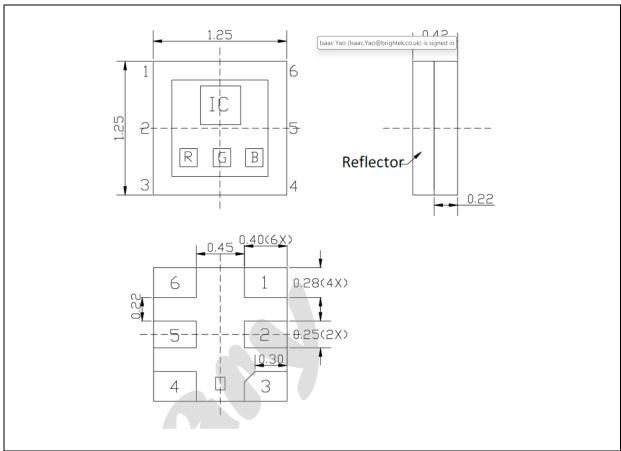
Switching Characteristics (Ta=25°C)

Parameter	Symbol		Values		Unit	Test	
raiailletei	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Rate of Data Signal	F _{DIN}		1	1.3	MHz	V _{DD} =5V	
Oscillation Frequency	Fosc		8		MHz	V _{DD} =5V	
PWM Frequency	F _{PWM}		4		KHZ		
Output Current Conversion	Tr			60	ns	V _{ds} =1.5V;	
Time	Tf			60	ns	I ₀ =12mA	
Transmission Delay Time	T _{pzl}			200	ns	$D_{IN} \rightarrow D_{OUT}$	



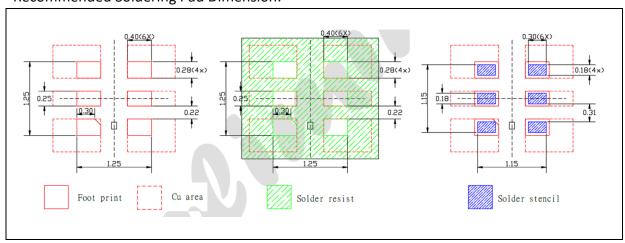
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

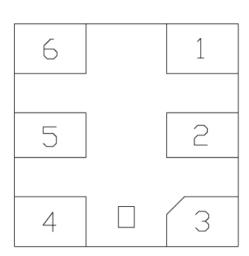
Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



PIN CONFIGURATION:



No.	Symbol	Function Description	
1	DIN2	Control Data Signal Input 2	
2	DIN1	Control Data Signal Input 1	
3	VDD	Power Supply Voltage	
4	DOUT1	Control Data Signal Output1	
5	NC	Not Connected	
6	GND	Ground	

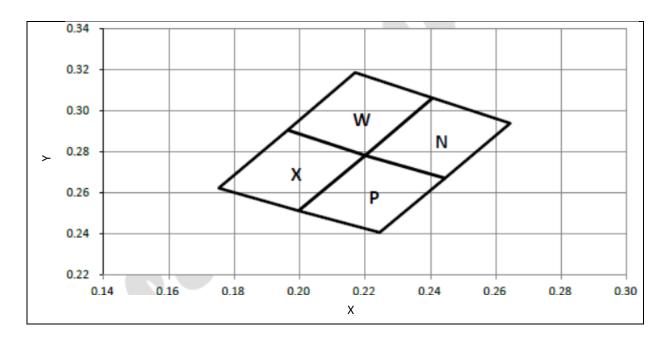


BINNING GROUPS:

Luminous Intensity Classifications (I_F=10.89mA, V_{DD}=5V, T_a=25°C):

Code	Min.	Max.	Unit
17	320	400	
18	400	500	mcd
19	500	630	

CIE CHROMATICITY DIAGRAM:



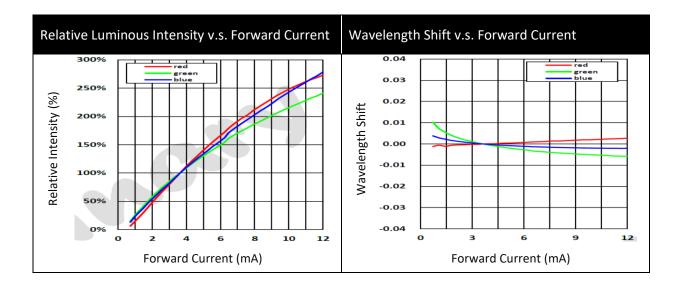
Chromaticity Coordinates Classifications:

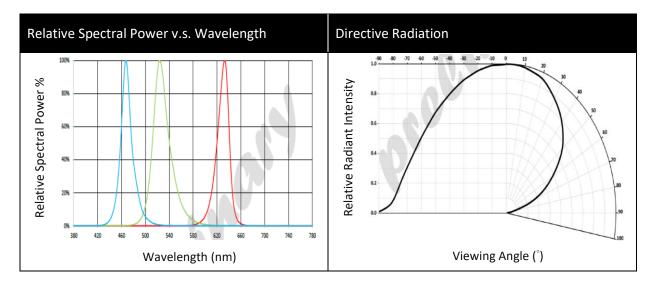
	1 2 3		3	2	4			
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
W	0.1963	0.2907	0.2169	0.3188	0.2406	0.3064	0.2200	0.2783
N	0.2200	0.2783	0.2406	0.3064	0.2643	0.2940	0.2444	0.2672
Х	0.1963	0.2907	0.1752	0.2624	0.1996	0.2513	0.2200	0.2783
Р	0.2200	0.2783	0.1996	0.2513	0.2244	0.2407	0.2444	0.2672

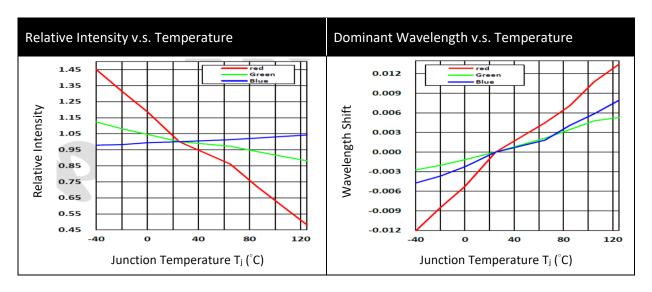
1. Tolerance Luminous Intensity: ±10%mcd, Color Coordinate: ±0.005



ELECTRO-OPTICAL CHARACTERISTICS:

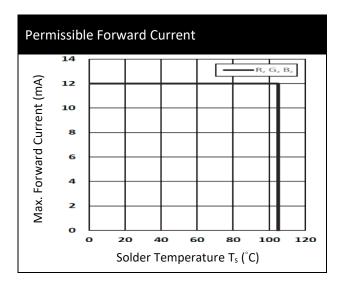








ELECTRO-OPTICAL CHARACTERISTICS:



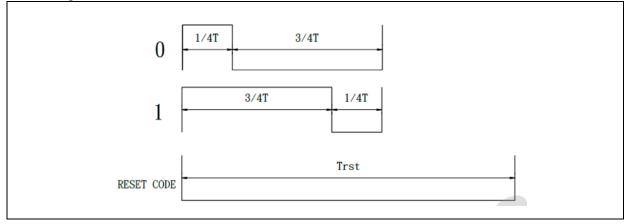


Function Description:

1. Current Gain (Dimming Level) Regulation

RGB Gain Setting	RGB Output (mA)		
0	0.71	10	6.47
1	1.07	11	6.83
2	1.46	12	7.22
3	1.81	13	7.60
4	2.18	14	7.96
5	2.55	15	8.34
6	2.94	16	8.73
7	3.30	17	9.08
8	3.63	18	9.40
9	3.98	19	9.77
Α	4.36	1A	10.15
В	4.74	1B	10.54
С	5.11	1 C	10.90
D	5.48	1D	11.27
E	5.87	1E	11.67
F	6.24	1F	12.00

2. Timing Wave Form:

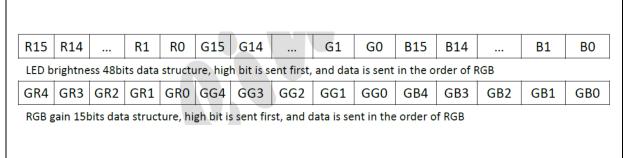


3. Data Transfer Time:

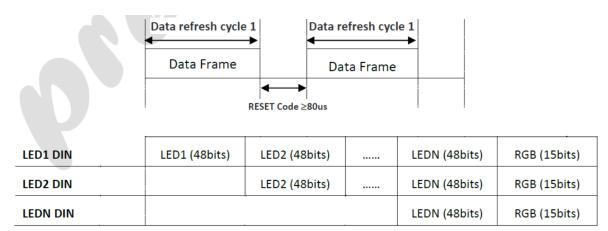
Item	Description	Typical	Tolerance
тон	0 code, high voltage time	0.24μs	±10%
TOL	0 code, low voltage time	0.48μs	±10%
T1H	1 code, high voltage time	0.48µs	±10%
T1L	1 code, low voltage time	0.24µs	±10%
Trst	reset time, low voltage time	≥80µs	-



4. Composition of 48bit Data:



5. Data transmission method:

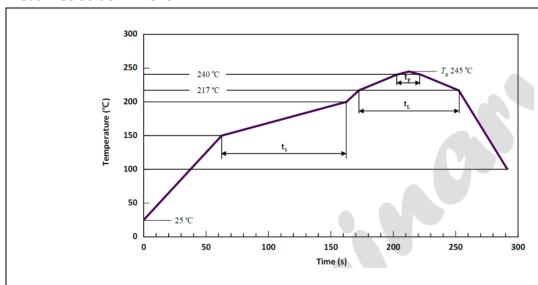


Note: The data frame D(1) is the data sent by the MCU, and D(2) and D(N) are the data that the cascade circuit automatically reshapes and forwards.



RECOMMENDED SOLDERING PROFILE:

Lead-free Solder IR Reflow:



Profile Feature	Symbol	Pb	bly	Unit	
		Minimum	Recommendation	Maximum	
Ramp-up Rate to Preheat 25 °C to 150 °C			2	3	K/s
Time ts T _{Smin} to T _{Smax}	ts	60	100	120	s
Ramp-up Rate to Peak T _{Smax} to T _P			2	3	K/s
Liquids Temperature	TL		217		°C
Time Above Liquids Temperature	tL		80	100	s
Peak Temperature	Tp		245	260	°C
Time Within 5 °C of the Specified Peak Temperature T _P - 5 K	Тр			10	s
Ramp-Down Rate T _P to 100 °C			3	4	K/s
Time 25 °C to T _P				480	S

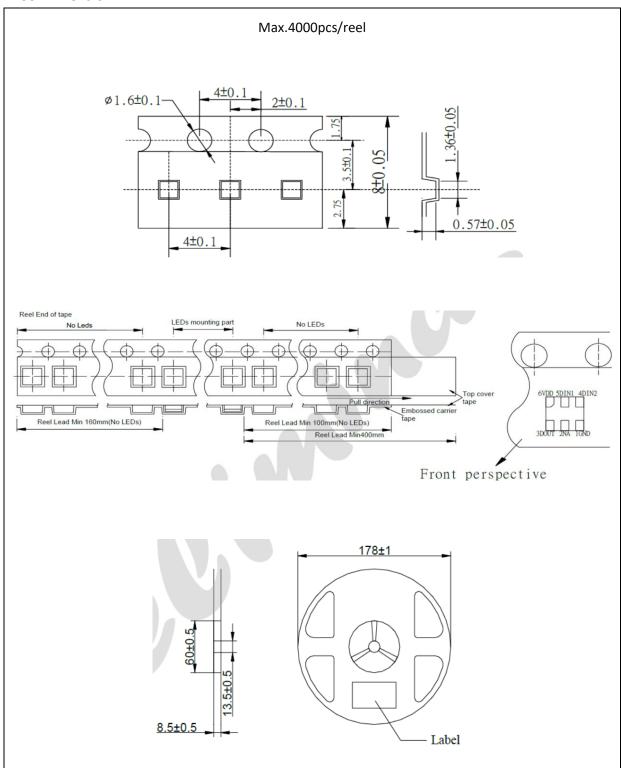
Note:

- 1. We recommend the reflow temperature 240°C (±5°C). The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent stored at R.H.<10% and apply baking before use.

Over-Current Proof:

Must apply resistors for protection otherwise slight voltage shift will cause big current change and burnout will happen.

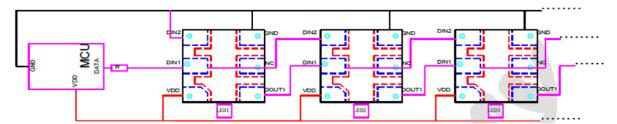
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Typical Application Circuit:



When the first LED is connected to the MCU, a resistance R is needed in series between its signal input line and the MCU. The size of R depends on the number of cascade beads. The more cascades, the smaller resistance R is used. It is generally recommended that the value be between 100-1K. Usually the recommended value is around 300 R. To make the LEDs work more stably, a parallel capacitor is needed between VDD and GND of each LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.



REVISION RECORD:

	Version	Date	Summary of Revision
Ī	A1.0	05/03/2024	Datasheet set-up.
ſ	A1.1	27/03/2024	Update title text.